

DATASHEET

Full Color Side View LEDs (Height 0.8mm) 99-235/RSGBB7C-A22/2D



Features

- · Inner reflector and white package.
- · Built in 3 LED chips.
- · Colorless clear resin
- Wide viewing angle 120°.
- · Ideal for backlight and light pipe application.
- · White SMT package.
- · Soldering methods: IR reflow soldering.
- · Precondition: Bases on JEDEC J-STD 020D Level 3
- Pb-free.
- · The product itself will remain within RoHS compliant version.
- · Compliance with EU REACH
- Compliance Halogen Free .(Br<900ppm,Cl<900ppm,Br+Cl<1500ppm)

Applications

- · Switches, symbol, mobile phone, digital camera and illuminated advertising.
- · Display for indoor and outdoor application.
- · Ideal for coupling into light guides.
- · Substitution of traditional light.
- Amusement equipment.
- General applications.
- · Optical indicator.



Device Selection Guide

Chip Materials	Emitted Color	Resin Color
AlGaInP	Brilliant Red	Water Clear
InGaN	Brilliant Green	Water Clear
InGaN	Blue	Water Clear

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol		Rating	Unit	
Reverse Voltage	V _R		5	V	
		RS	30		
Forward Current	I _F	GB	30	mA	
		В7	30		
		RS	100		
Peak Forward Current	I _{FP}	GB	100	mA	
(Duty 1/10 @1KHz)		В7	100		
		RS	110		
Power Dissipation	Pd	GB	110	mW	
		В7	110		
Junction Temperature	Tj		115	$^{\circ}\!\mathbb{C}$	
Operating Temperature	Topr		-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg		-40 ~ +90	$^{\circ}\!\mathbb{C}$	
	_	RS	2000		
ESD	ESDнвм	GB	1000	V	
	•	В7	1000		
Soldering Temperature	T _{sol}	Reflow Soldering : 260 $^{\circ}\mathbb{C}$ for 10 sec. Hand Soldering : 350 $^{\circ}\mathbb{C}$ for 3 sec.			



Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol		Min.	Тур.	Max.	Unit	Condition
	_	RS	285		715	_	
Luminous Intensity	lv	GB	710		1800	mcd	
		В7	72		180		_
Viewing Angle	201/2			120		deg	_
	_	RS	618		627	_	
Dominant Wavelength	λd	GB	520		535	nm -	R:I _F =17mA G:I _F =18mA B:I _F =9mA
		В7	457		466		
	_	RS	1.80		2.30	_	
Forward Voltage	V _F	GB	2.75		3.45	V	
		B7	2.75		3.45		_
White point coordinate	X			0.294			
	у			0.286			
Reverse Current	I _R	RS			10	μΑ	V _R =5V

Notes:

- 1. Tolerance of Luminous Intensity: ±11%
- 2. Tolerance of Dominant Wavelength: ±1nm
- 3. Tolerance of Forward Voltage: ±0.1V



Bin Range of Luminous Intensity

		•			
Chip	Bin Code	Min.	Max.	Unit	Condition
	T1	285	360		R:I _F =17mA G:I _F =18mA B:I _F =9mA
D0	T2	360	450		
RS	U1	450	560		
	U2	560	715		
	V1	710	900		
0.5	V2	900	1120		
GB	AA	1120	1400	mcd	
	AB	1400	1800		
	Q1	72	90		
B7 -	Q2	90	112		
	R1	112	140		
	R2	140	180		

Bin Range of Forward Voltage

Chip	Bin Code	Min.	Max.	Unit	Condition
DC	RV1	1.80	2.05		
RS -	RV2	2.05	2.3	V	R:I _F =17mA G:I _F =18mA B:I _F =9mA
GB -	GV1	2.75	3.10		
	GV2	3.10	3.45		
В7 —	BV1	2.75	3.10		
	BV2	3.1	3.45		

Note:

- 1. Tolerance of Luminous Intensity: $\pm 11\%$
- 2. Tolerance of Forward Voltage: ±0.1V



Bin Range of Chromaticity Coordinates Specifications R/G/B=17/18/9mA

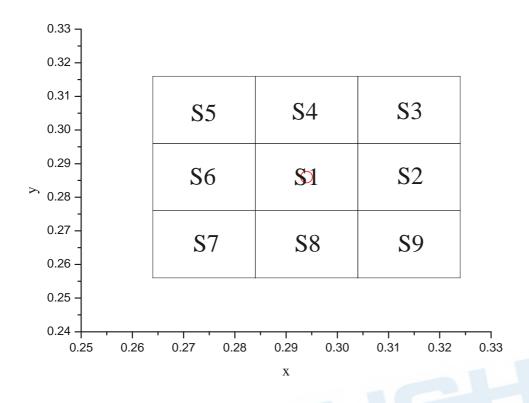
Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y
04	0.284	0.276	S2	0.304	0.276
	0.284	0.296		0.304	0.296
S1	0.304	0.296		0.324	0.296
	0.304	0.276		0.324	0.276
	0.304	0.296		0.284	0.296
S3	0.304	0.316	84	0.284	0.316
33	0.324	0.316	S4	0.304	0.316
	0.324	0.296		0.304	0.296
	0.264	0.296	S6	0.264	0.276
S5	0.264	0.316		0.264	0.296
35	0.284	0.316		0.284	0.296
	0.284	0.296		0.284	0.276
	0.264	0.256	S8	0.284	0.256
97	0.264	0.276		0.284	0.276
S7	0.284	0.276		0.304	0.276
	0.284	0.256		0.304	0.256
S 9	0.304	0.256			
	0.304	0.276			
	0.324	0.276			
	0.324	0.256			

Note:

Tolerance of Chromaticity Coordinates: ±0.01.

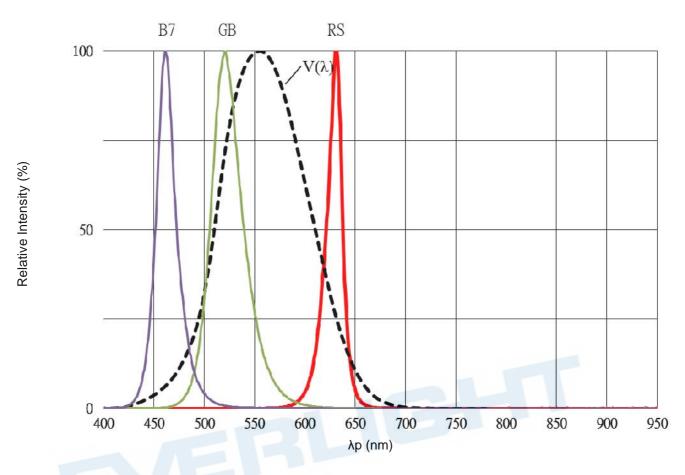


The C.I.E. 1931 Chromaticity Diagram R/G/B=17/18/9mA



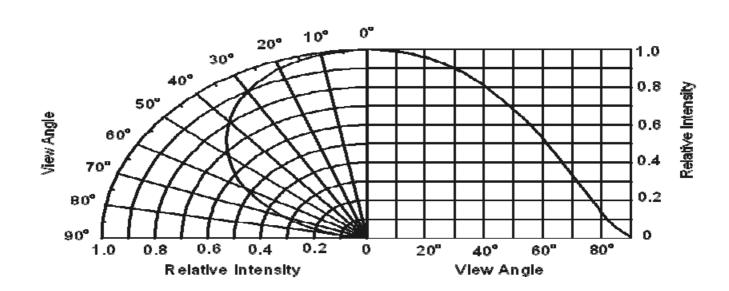


Typical Electro-Optical Characteristics Curves Typical Curve of Spectral Distribution



Note: $V(\lambda)$ =Standard eye response curve;

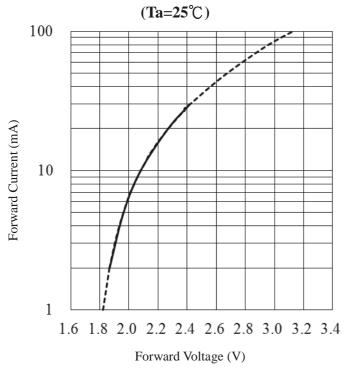
Diagram Characteristics of Radiation



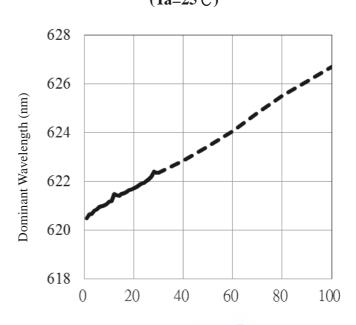


Typical Electro-Optical Characteristics Curves(RS)

Forward Current vs. Forward Voltage

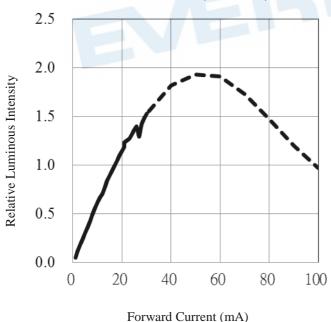


Dominant Wavelength vs. Forward Current (Ta=25°C)

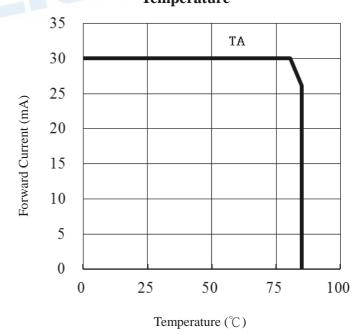


Forward Current (mA)

Relative Luminous Intensity vs. Forward Current (Ta=25°C)



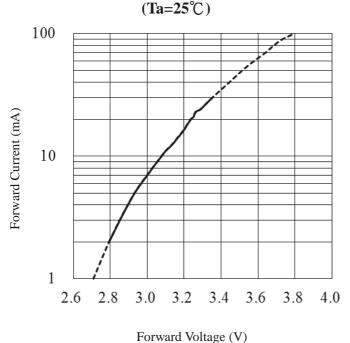
Forward current vs. Ambient and Solder Temperature



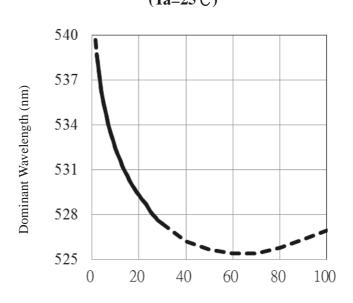


Typical Electro-Optical Characteristics Curves(GB)

Forward Current vs. Forward Voltage

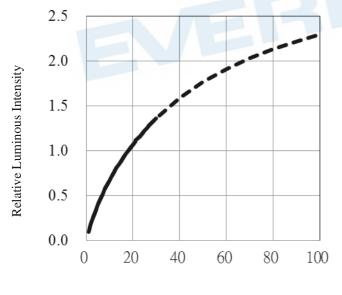


Dominant Wavelength vs. Forward Current (Ta=25°C)



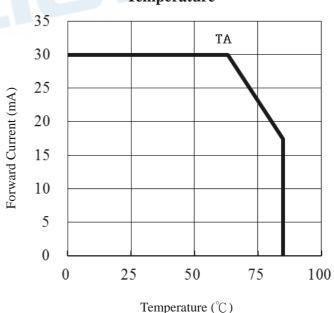
Forward Current (mA)

Relative Luminous Intensity vs. Forward Current (Ta=25°C)



Forward Current (mA)

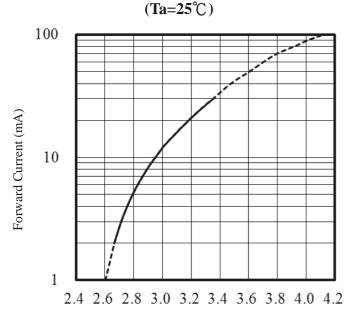
Forward current vs. Ambient and Solder Temperature





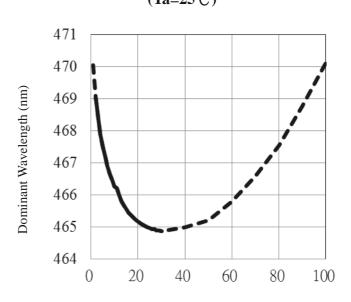
Typical Electro-Optical Characteristics Curves(B7)

Forward Current vs. Forward Voltage



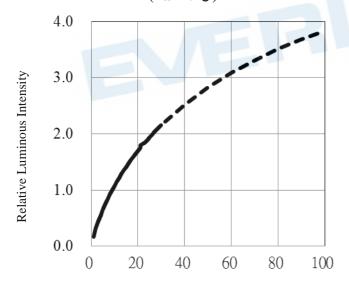
Forward Voltage (V)

Dominant Wavelength vs. Forward Current (Ta=25°C)



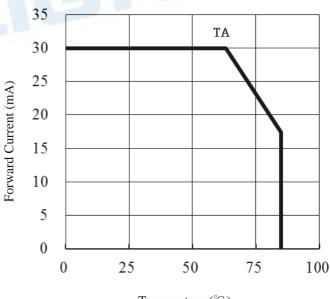
Forward Current (mA)

Relative Luminous Intensity vs.Forward Current (Ta=25°C)



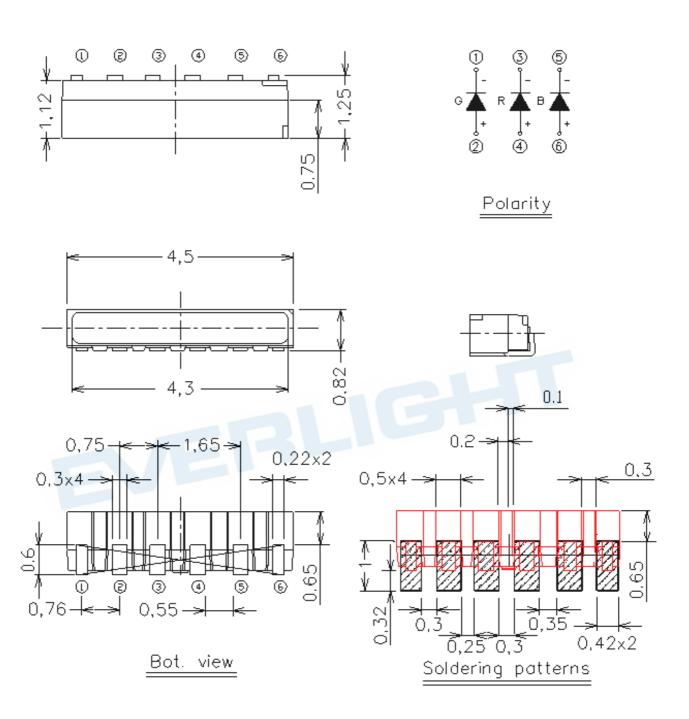
Forward Current (mA)

Forward current vs. Ambient and Solder Temperature





Package Dimension



Note: Tolerances unless mentioned ± 0.1 mm. Unit = mm



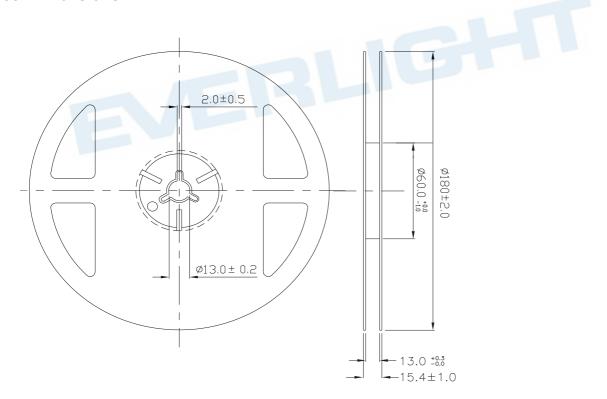
Moisture Resistant Packing Materials

Label Explanation



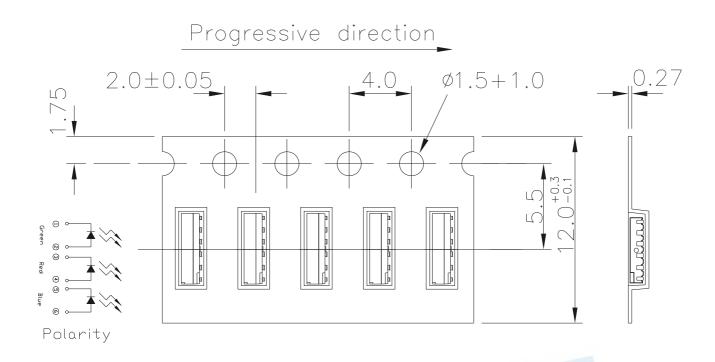
- · CPN: Customer's Product Number
- P/N: Product Number
- · QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- · HUE: Dom. Wavelength Rank
- REF: Forward Voltage Rank
- · LOT No: Lot Number

Reel Dimensions





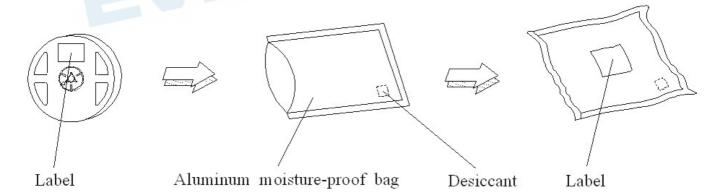
Carrier Tape Dimensions: Loaded Quantity 2000 pcs Per Reel



Note:

Tolerances unless mentioned ±0.1mm. Unit = mm

Moisture Resistant Packing Process

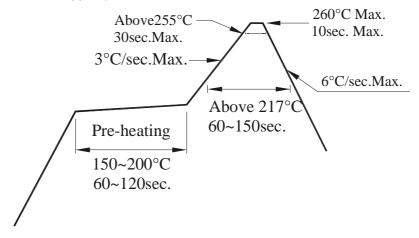




Precautions for Use

1. Over-current-proof

1.1 Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).



2. Storage

- 2.1 Moisture proof bag should only be opened immediately prior to usage.
- 2.2 Environment should be less than 30°C and 60% RH when moisture proof bag is opened.
- 2.3 After opening the package MSL Conditions stated on page 1 of this spec should not be exceeded.
- 2.4 If the moisture sensitivity card indicates higher than acceptable moisture, the component should be baked at min. 60deg +/-5deg for 24 hours.

3. Soldering Condition

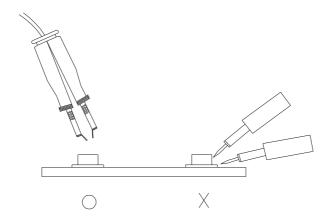
- 3.1 Pb-free solder temperature profile
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.





Application Restrictions

High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.

DISCLAIMER

- 1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
- 2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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